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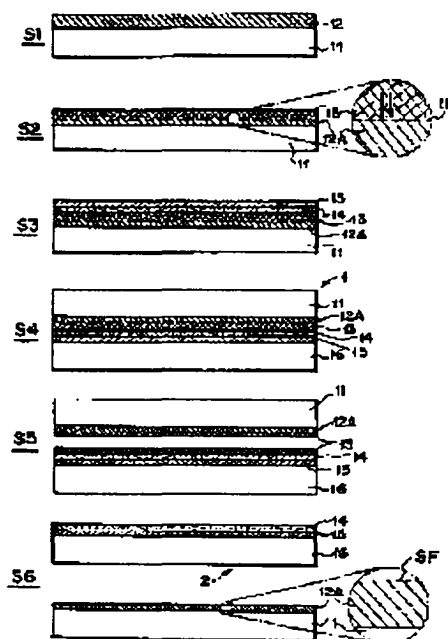
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(54) MANUFACTURE OF SEMICONDUCTOR MEMBER AND SEMICONDUCTOR MEMBER

(57)Abstract:

PROBLEM TO BE SOLVED: To provide an inexpensive method for manufacturing a semiconductor member, in which the irregularities of a boundary face between a porous layer and a substrate can be reduced, and the reproducibility of a separating position can be increased.

SOLUTION: This method includes a process for forming an additional layer 12, to which an element for controlling a conductive type is added on at least one surface side of a semiconductor substrate 11, making porous the surface of the additional layer 12 for obtaining a porous layer 13 which is smaller in thickness than that of the additional layer 12, and forming a non-porous layer 14 on the porous layer 13 for preparing a first substrate, a process for adhering the first substrate to a second substrate 16 for obtaining a multilayer structure in which the non-porous layer 14 is positioned inside, and a process for separating the multi-layer structure from the porous layer 13.



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